N(1) 07-08-13 RECORDATION FORM COVER SHEE		(CT)   (CT)   CT     CT     CT     CT     CT     CT     CT     CT     CT					
To the Director of the U.S. Patent and Trademark Office: Please	record the attached doc						
1. Name of conveying party(ies)	2. Name and add	103660083					
1) Akinori YUTANI 2) Kouji SOEJIMA.  2 JUL 0 8 2013 &	Name: Renesas	Electronics Corporation					
2) Kouji SOEJIMA	Internal Address:						
Additional name(s) of conveying party(ies) attached 40 200							
3. Nature of conveyance/Execution Date(s): Execution Date(s) 1) 06/21/2013; 2) 06/09/2013	Street Address: 17	753, Shimonumabe, Nakahara-ku					
☐ Assignment ☐ Merger							
☐ Security Agreement ☐ Change of Name	City: Kawasaki-shi						
Joint Research Agreement	State: Kanaga						
Government Interest Assignment	Country: Japan						
<ul><li>☐ Executive Order 9424, Confirmatory License</li><li>☐ Other</li></ul>							
		& address(es) attached? Yes X No liled together with a new application.					
4. Application or patent number(s):  A. Patent Application No.(s)	B. Patent No.(s)	med together with a new application.					
13/752,194							
Additional numbers attac	hed? Yes 🛛 N	0					
5. Name and address to whom correspondence	6. Total number of applications and patents						
concerning document should be mailed: Name: Sean M. McGinn, Esq.		1					
Internal Address: 34,386	<b>7. Total fee</b> (37 Cl	FR 1.21(h) & 3.41) \$ 40.00					
McGinn Intellectual Property Law Group, PLLC	X A. Maranima al 4a 1						
Street Address: 8321 Old Courthouse Road	Enclosed	pe charged to deposit account					
Suite 200	i .	(government interest not affecting title)					
City: Vienna	8. Payment Infor						
State: Virginia Zip: 22182-3817							
Phone Number: (703) 761-4100		·					
Fax Number: (703) 761-2375 or 76	Deposit Acc	ount Number 50-0481 (deficiencies only)					
Email Address: ADMIN@MCGINNIPLAW.COM	Authorized \						
2011111	1						
9. Signature: Signature		July 8, 2013					
Sean M. McGinn, Esq.	Т	37/12/2013 HT0N11 09@ate4 13752194 otal number of pages including cover 49.00					
Name of Person Signing		Sheek attachments, and documents:					

Documents to be recorded (including cover sheet) should be faxed to (571) 273-0140, or mailed to: Mail Stop Assignment Recordation Services, Director of the USPTO, P.O.Box 1450, Alexandria, V.A. 22313-1450

**REEL: 030815 FRAME: 0606** 

Docket No.: REN. 10 V Only After Sept 16, 2012

## ASSIGNMENT WITH DECLARATION FOR UTILITY OR DESIGN PATENT APPLICATION (37 CFR 1.63)

Whereas, I/We, the undersigned inventor(s) hereinafter called assignor(s), have invented certain improvements described in the application identified below; and

Whereas, Renesas Electronics Corporation of Kanagawa, Japan, (assignee), desires to acquire the entire right, title, and interest in the application and invention, and to any United States patents to be obtained therefor;

Now therefore, for valuable consideration, receipt whereof is hereby acknowledged,

Access to Application by Participating Office.

I/We, the above named assignor(s), hereby sell, assign and transfer to the above named assignee, its successors and assigns, the entire right, title and interest in the application and the invention disclosed therein for the United States of America, including all divisions, and continuations thereof, and all Letters Patent of the United States that may be granted thereon, and all reissues thereof, including the right to claim priority under 35 USC 119, and I/we request the Director of the U.S. Patent and Trademark Office to issue any Letters Patent granted upon the invention set forth in the application to the assignee, its successors and assigns; and I/we will execute without further consideration all papers deemed necessary by the assignee in connection with the United States application when called upon to do so by the assignee.

(Legalization not required for recording	g but is	prima facie evidence of execution under 35 USC 261)
As the below named inventor, I hereby	/ declare	e that:
This assignment with declaration is directed to:		The attached application, or
	X	United States Application or PCT International Application Number 13/752194
•		filed on January 28, 2013.
The application is entitled:		
METHO	DD OF N	MANUFACTURING A SEMICONDUCTOR DEVICE AND WAFER
The above identified application was n	nade or	was authorized to be made by me.
I believe that I am the original invento	roran	original joint inventor of a claimed invention in the application.
I have reviewed and understand the c	ontents	of the application for which this assignment with declaration is being submitted.
I am aware of the duty to disclose to	the Offi	ce all information known to me to be material to patentability as defined in 37 CFR 1.56.
I hereby acknowledge that any willful or imprisonment of not more than five		atement made in this assignment with declaration is punishable under 18 USC 1001 by fine rs, or both.
Authorization To Permit Access To	Applicat	ion by Participating Office
(JPO), the Korean Intellectual Proper property offices in which a foreign apparent application. See 37 CFR 1.14(c	ty Office olication ol and (h	s the USPTO authority to provide the European Patent Office (EPO), the Japan Patent Office (KIPO), the World Intellectual Property Office (WIPO), and any other intellectual claiming priority to the above-identified application is filed access to the above-identified by This box should not be checked if the applicant does not wish the EPO, JPO, KIPO, or or or application claiming priority to the above-identified application is filed to have
identified patent application-as-filed. 119(a)-(d) if a copy of the foreign app	2) any f dication	will be provided to a copy of the application—as-filed with respect to: 1) the above—oreign application to which the above—identified application claims priority under 35 USC that satisfies the certified copy requirement of 37 CFR 1.55 has been filed in the above—application—as—filed from which benefit is sought in the above—identified patent application.
In accordance with 37 CFR 1.14(c), a	ccess m	ay be provided to information concerning the date of filing the Authorization to Permit

Page 1 of 2

FORE MANIE OF SHADINGS	74111011 10171114			·····			
Inventor's Signature	Akin	uori	Yutani		Date	June 21,	20/3
Legal Name of Additional 1	inventor, If Any	<u>Kouj</u>	i SOEJIMA		······································		
Inventor's Signature					Date		

Docket No.: REN.102 Only After Sept 16, 2012

## ASSIGNMENT WITH DECLARATION FOR UTILITY OR DESIGN PATENT APPLICATION (37 CFR 1.63)

Whereas, I/We, the undersigned inventor(s) hereinafter called assignor(s), have invented certain improvements described in the application identified below; and

Whereas, Renesas Electronics Corporation of Kanagawa, Japan, (assignee), desires to acquire the entire right, title, and interest in the application and invention, and to any United States patents to be obtained therefor;

Now therefore, for valuable consideration, receipt whereof is hereby acknowledged,

Access to Application by Participating Office.

I/We, the above named assignor(s), hereby sell, assign and transfer to the above named assignee, its successors and assigns, the entire right, title and interest in the application and the invention disclosed therein for the United States of America, including all divisions, and continuations thereof, and all Letters Patent of the United States that may be granted thereon, and all reissues thereof, including the right to claim priority under 35 USC 119, and I/we request the Director of the U.S. Patent and Trademark Office to issue any Letters Patent granted upon the invention set forth in the application to the assignee, its successors and assigns; and I/we will execute without further consideration all papers deemed necessary by the assignee in connection with the United States application when called upon to do so by the assignee.

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(Legalization not required for recording	but is prima facie evidence of execution under 35 USC 261)
As the below named inventor, I hereby	declare that:
This assignment with declaration is directed to:	The attached application, or
	□ United States Application or PCT International Application Number 13/752194
	filed on January 28, 2013.
The application is entitled:	
METHO	DO OF MANUFACTURING A SEMICONDUCTOR DEVICE AND WAFER
The above identified application was n	nade or was authorized to be made by me.
I believe that I am the original invento	r or an original joint inventor of a claimed invention in the application.
I have reviewed and understand the co	ontents of the application for which this assignment with declaration is being submitted.
I am aware of the duty to disclose to	the Office all information known to me to be material to patentability as defined in 37 CFR 1.56.
I hereby acknowledge that any willful or imprisonment of not more than five	false statement made in this assignment with declaration is punishable under 18 USC 1001 by fine (5) years, or both.
Authorization To Permit Access To	Application by Participating Office
(JPO), the Korean Intellectual Property offices in which a foreign apparent application. See 37 CFR 1.14(c	by grants the USPTO authority to provide the European Patent Office (EPO), the Japan Patent Office (VIPO), the World Intellectual Property Office (WIPO), and any other intellectual plication claiming priority to the above-identified application is filed access to the above-identified and (h). This box should not be checked if the applicant does not wish the EPO, JPO, KIPO, or nich a foreign application claiming priority to the above-identified application is filed to have
identified patent application-as-filed, 119(a)-(d) if a copy of the foreign app	access will be provided to a copy of the application—as—filed with respect to: 1) the above—2) any foreign application to which the above—identified application claims priority under 35 USC dication that satisfies the certified copy requirement of 37 CFR 1.55 has been filed in the above—by U.S. application—as—filed from which benefit is sought in the above—identified patent application.
In accordance with 37 CFR 1.14(c), a	ccess may be provided to information concerning the date of filing the Authorization to Permit

Page 1 of 2

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Inventor's Signature		Philippen Agreement and the Company of the Company	Date			North-Addison of the Addison of the	
Legal Name of Additional Inve	entor, If Any	Kouji SOEJIMA					
Inventor's Signature	Kosi	Soenne	Date	June	9	,2013	

Page 2 of 2